# **3.2 Watt Plastic Surface Mount POWERMITE<sup>®</sup> Package**

This complete new line of 3.2 Watt Zener Diodes are offered in highly efficient micro miniature, space saving surface mount with its unique heat sink design. The POWERMITE package has the same thermal performance as the SMA while being 50% smaller in footprint area and delivering one of the lowest height profiles (1.1 mm) in the industry. Because of its small size, it is ideal for use in cellular phones, portable devices, business machines and many other industrial/consumer applications.

#### Features

- Zener Breakdown Voltage: 6.2 47 V
- DC Power Dissipation: 3.2 W with Tab 1 (Cathode) @ 75°C
- Low Leakage  $< 5 \mu A$
- ESD Rating of Class 3 (> 16 kV) per Human Body Model
- Low Profile Maximum Height of 1.1 mm
- Integral Heat Sink/Locking Tabs
- Full Metallic Bottom Eliminates Flux Entrapment
- Small Footprint Footprint Area of 8.45 mm<sup>2</sup>
- Supplied in 12 mm Tape and Reel
- Lead Orientation in Tape: Cathode (Short) Lead to Sprocket Holes
- POWERMITE is JEDEC Registered as DO-216AA
- Cathode Indicated by Polarity Band
- These Devices are Pb-Free and are RoHS Compliant

#### **Mechanical Characteristics**

**CASE:** Void-free, transfer-molded, thermosetting plastic **FINISH:** All external surfaces are corrosion resistant and leads are readily solderable

**MOUNTING POSITION:** Any

### MAXIMUM CASE TEMPERATURE FOR SOLDERING PURPOSES:

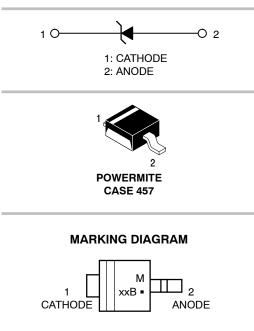
260°C for 10 Seconds

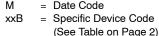


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## PLASTIC SURFACE MOUNT 3.2 WATT ZENER DIODES 6.2 – 47 VOLTS





= Pb-Free Package

#### **ORDERING INFORMATION**

| Device       | Package                | Shipping <sup>†</sup> |  |  |
|--------------|------------------------|-----------------------|--|--|
| 1PMT59xxBT1G | POWERMITE<br>(Pb-Free) | 3000 / Tape &<br>Reel |  |  |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Downloaded from Arrow.com.

#### MAXIMUM RATINGS

| Rating  | Symbol   | Value             | Unit                |  |
|---|--|-------------------|---------------------|--|
| DC Power Dissipation @ T <sub>A</sub> = 25°C (Note 1)<br>Derate above 25°C<br>Thermal Resistance, Junction-to-Ambient | Ρ <sub>D</sub><br>R <sub>θJA</sub>                       | 500<br>4.0<br>248 | mW<br>mW/°C<br>°C/W |  |
| Thermal Resistance, Junction-to-Lead (Anode)  | $R_{\theta Janode}$                                      | 35                | °C/W                |  |
| Maximum DC Power Dissipation (Note 2)<br>Thermal Resistance from Junction-to-Tab (Cathode)                            | $\begin{array}{c} P_D \\ R_{\thetaJcathode} \end{array}$ | 3.2<br>23         | W<br>°C/W           |  |
| Operating and Storage Temperature Range   | T <sub>J</sub> , T <sub>stg</sub>                        | –55 to +150       | °C                  |  |

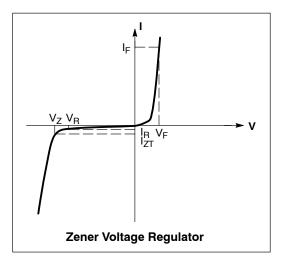
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Mounted with recommended minimum pad size, PC board FR-4.

2. At Tab (Cathode) temperature,  $T_{tab} = 75^{\circ}C$ 

| ELECTRICAL CHARACTERISTICS (T <sub>L</sub> = 25°C unless                                |
|---|
| otherwise noted, V <sub>F</sub> = 1.5 V Max. @ I <sub>F</sub> = 200 mAdc for all types) |

| Symbol          | Parameter                                 |  |  |  |  |  |
|-----------------|---|--|--|--|--|--|
| VZ              | Reverse Zener Voltage @ I <sub>ZT</sub>   |  |  |  |  |  |
| I <sub>ZT</sub> | Reverse Current                           |  |  |  |  |  |
| Z <sub>ZT</sub> | Maximum Zener Impedance @ I <sub>ZT</sub> |  |  |  |  |  |
| I <sub>ZK</sub> | Reverse Current                           |  |  |  |  |  |
| Z <sub>ZK</sub> | Maximum Zener Impedance @ I <sub>ZK</sub> |  |  |  |  |  |
| I <sub>R</sub>  | Reverse Leakage Current @ V <sub>R</sub>  |  |  |  |  |  |
| V <sub>R</sub>  | Reverse Voltage                           |  |  |  |  |  |
| ١ <sub>F</sub>  | Forward Current                           |  |  |  |  |  |
| V <sub>F</sub>  | Forward Voltage @ I <sub>F</sub>          |  |  |  |  |  |



#### **ELECTRICAL CHARACTERISTICS** ( $T_L = 30^{\circ}C$ unless otherwise noted, $V_F = 1.25$ Volts @ 200 mA)

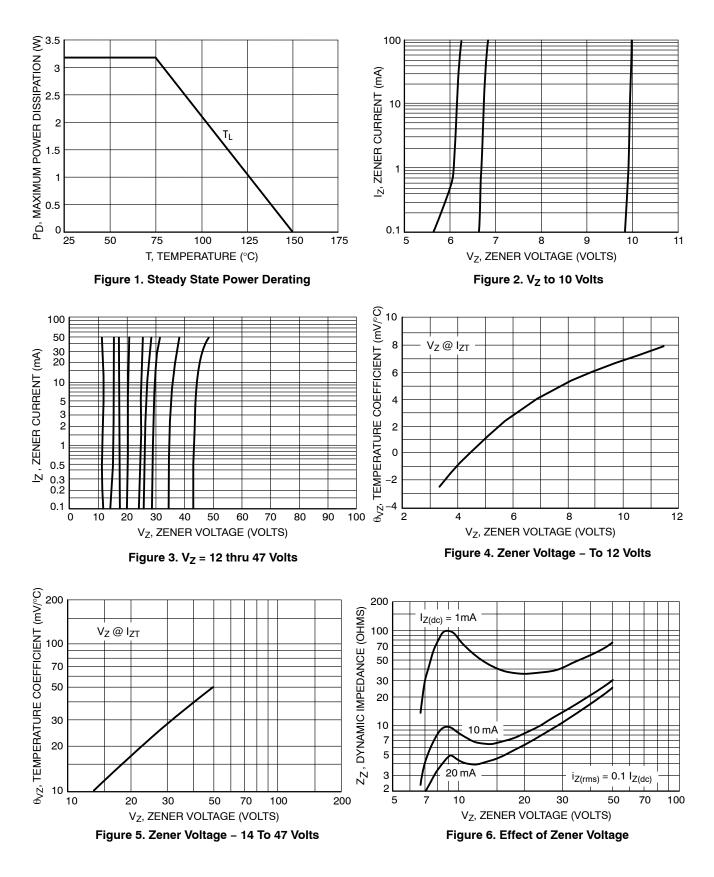
|              |        | Zener Voltage (Note 3)                   |     |                 |                                 |      |          | Z <sub>ZT</sub> @ I <sub>ZT</sub> | Z <sub>ZK</sub> @ I <sub>ZK</sub> |      |
|--------------|--------|--|-----|-----------------|---------------------------------|------|----------|-----------------------------------|-----------------------------------|------|
|              | Device | V <sub>Z</sub> @ I <sub>ZT</sub> (Volts) |     | I <sub>ZT</sub> | I <sub>R</sub> @ V <sub>R</sub> | VR   | (Note 4) | (Note 4)                          | I <sub>ZK</sub>                   |      |
| Device*      |        | Min                                      | Nom | Max             | (mA)                            | (μΑ) | (V)      | (Ω)                               | (Ω)                               | (mA) |
| 1PMT5920BT1G | 20B    | 5.89                                     | 6.2 | 6.51            | 60.5                            | 5.0  | 4.0      | 2.0                               | 200                               | 1.0  |
| 1PMT5921BT1G | 21B    | 6.46                                     | 6.8 | 7.14            | 55.1                            | 5.0  | 5.2      | 2.5                               | 200                               | 1.0  |
| 1PMT5924BT1G | 24B    | 8.64                                     | 9.1 | 9.56            | 41.2                            | 5.0  | 7.0      | 4.0                               | 500                               | 0.5  |
| 1PMT5927BT1G | 27B    | 11.4                                     | 12  | 12.6            | 31.2                            | 1.0  | 9.1      | 6.5                               | 550                               | 0.25 |
| 1PMT5929BT1G | 29B    | 14.25                                    | 15  | 15.75           | 25                              | 1.0  | 11.4     | 9.0                               | 600                               | 0.25 |
| 1PMT5933BT1G | 33B    | 20.9                                     | 22  | 23.1            | 17                              | 1.0  | 16.7     | 17.5                              | 650                               | 0.25 |
| 1PMT5934BT1G | 34B    | 22.8                                     | 24  | 25.2            | 15.6                            | 1.0  | 18.2     | 19                                | 700                               | 0.25 |
| 1PMT5935BT1G | 35B    | 25.65                                    | 27  | 28.35           | 13.9                            | 1.0  | 20.6     | 23                                | 700                               | 0.25 |
| 1PMT5941BT1G | 41B    | 44.65                                    | 47  | 49.35           | 8.0                             | 1.0  | 35.8     | 67                                | 1000                              | 0.25 |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

3. Zener voltage is measured with the device junction in thermal equilibrium with an ambient temperature of 25°C.

4. Zener Impedance Derivation  $Z_{ZT}$  and  $Z_{ZK}$  are measured by dividing the AC voltage drop across the device by the AC current applied. The specified limits are for  $I_Z(ac) = 0.1 I_Z(dc)$  with the ac frequency = 60 Hz.

#### **TYPICAL CHARACTERISTICS**



#### **TYPICAL CHARACTERISTICS**

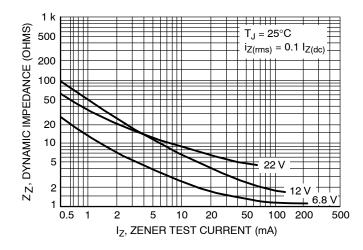
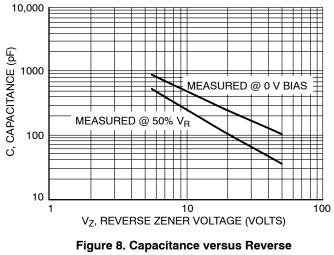


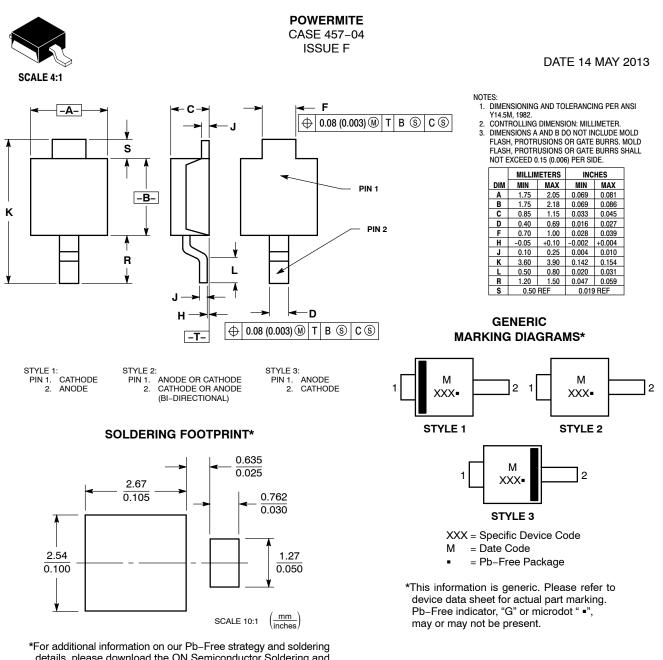
Figure 7. Effect of Zener Current



Zener Voltage

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Aror additional information on our PD-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

 
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 DESCRIPTION:
 POWERMITE
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